

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6084448

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
RICHARD TE GAN	12/17/2019
RUSHIK PRABHUDAS TANK	12/18/2019
ZHIWEI GONG	12/17/2019
BURTON JESSE CARPENTER	12/17/2019
JINMEI LIU	12/18/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	NXP USA, INC.
<b>Street Address:</b>	6501 WILLIAM CANNON DRIVE WEST
<b>City:</b>	AUSTIN
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	78735
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16862027
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	Tracy.Buffett@nxp.com
<b>Correspondent Name:</b>	NXP USA, INC.
<b>Address Line 1:</b>	6501 WILLIAM CANNON DRIVE WEST
<b>Address Line 4:</b>	AUSTIN, TEXAS 78735
<b>ATTORNEY DOCKET NUMBER:</b>	82176454US02
<b>NAME OF SUBMITTER:</b>	TRACY BUFFETT
<b>SIGNATURE:</b>	/Tracy Buffett/
<b>DATE SIGNED:</b>	04/29/2020
<b>Total Attachments: 5</b>	
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source=82176454US02-ASSIGNMENT-Signed#page4.tif  
source=82176454US02-ASSIGNMENT-Signed#page5.tif

**ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, we, as below-named Assignor/s, hereby sell, assign, and transfer the entire and exclusive right, title, and interest in the following to **NXP USA, INC.**, having a place of business at 6501 William Cannon Drive, Austin, TX 78735, USA, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

(1) our invention relating to "TIE BAR REMOVAL FOR SEMICONDUCTOR DEVICE PACKAGING" for which the following patent application(s) has/have been filed (we hereby authorize and request my/our attorneys associated with U.S. Patent & Trademark Office Customer Number 23125 to insert below the filing date and application number of the U.S. application when known):

<u>Country</u>	<u>Application No.</u>	<u>Filing Date (mm/dd/yyyy)</u>	<u>Claims Priority of</u>
CN	201911373697.6	2019/12/26	

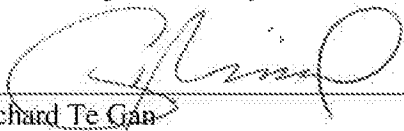
(2) the foregoing application(s) and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority there from including, but not limited to, any and all provisionals, non-provisionals, divisions, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and

(3) the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

We authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to **NXP USA, INC.**, for its sole use, and that of its successors, assigns, and legal representatives.

We will provide our cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, we agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutorial actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

We certify that we have the full right to convey the above rights.

DEC. 17, 2019		Assignor
Date	Richard Te Gan	
		Assignor
Date	Rushik Prabhudas Tank	
		Assignor
Date	Zhiwei Gong	
		Assignor
Date	Burton Jesse Carpenter	
		Assignor
Date	Jinmei Liu	

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12/18/2019		
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Date	Rushik Prabhudas Tank	
_____	_____	Assignor
Date	Zhiwei Gong	
_____	_____	Assignor
Date	Burton Jesse Carpenter	
_____	_____	Assignor
Date	Jinmei Liu	

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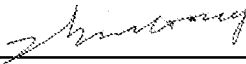
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_____	_____	_____	_____
Date	Richard Te Gan		, Assignor
_____	_____	_____	_____
Date	Rushik Prabhudas Tank		, Assignor
<u>December 17, 2019</u>		_____	_____
Date	Zhiwei Gong		, Assignor
_____	_____	_____	_____
Date	Burton Jesse Carpenter		, Assignor
_____	_____	_____	_____
Date	Jinmei Liu		, Assignor

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\_\_\_\_\_, Assignor  
Date Richard Te Gan

\_\_\_\_\_, Assignor  
Date Rushik Prabhudas Tank

\_\_\_\_\_, Assignor  
Date Zhiwei Gong

\_\_\_\_\_, Assignor  
Date Dec 17, 2019  
Burton Jesse Carpenter

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_____	_____	Assignor
Date	Burton Jesse Carpenter	
<u>Dec 18, 2019</u>	<u>Jinmei Liu</u>	Assignor
Date	Jinmei Liu	